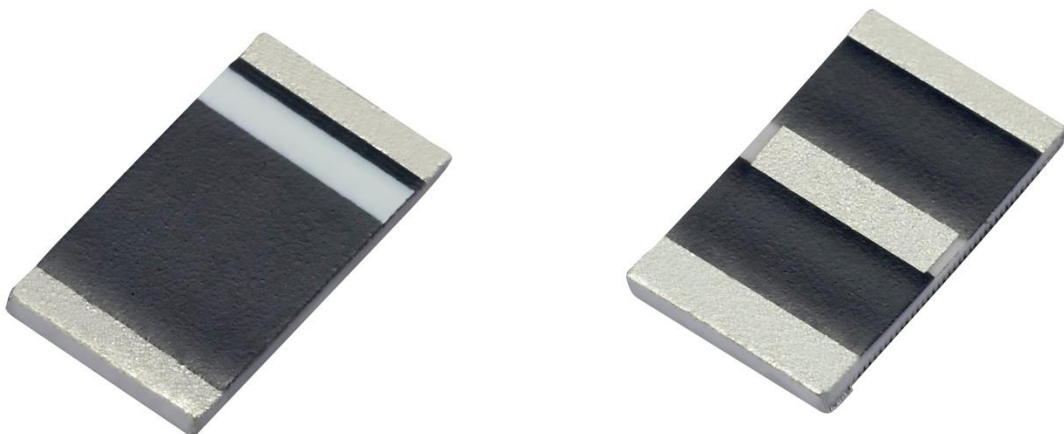


## SPECIFICATION

<b>Part No.</b>	<b>: ILA.09</b>
<b>Description</b>	: ISM 915MHz Chip Antenna for ISM / LoRa / LPWAN / Sigfox
<b>Features</b>	: High Efficiency Omnidirectional Low Profile Compact Size Surface-Mount 5.0*3.0*0.5mm RoHS Compliant



## 1. Introduction

The ILA.09 is a new 915MHz ISM band embedded ceramic loop antenna from Taoglas featuring good efficiency of 55% at the center of the band. It is the perfect solution for the growing number of devices using the 915MHz band such as Sigfox and LoRa applications in the US, or in metering application.

This antenna works best when placed at the center of the board edge. The ILA.09 antenna, at 5\*3\*0.5mm, is low profile and would be suitable for devices with space constraints. The ILA.09 is delivered on tape and reel and now allows M2M customers to use an omnidirectional SMT antenna. The omnidirectional radiation characteristics allow for excellent performance regardless of device orientation. This is especially useful for devices that are not fixed in one particular spot during use. When there is little PCB space available for antenna placement, but high performance is required, the ILA.09 is the ideal choice.

The antenna is manufactured in a TS16949 first tier automotive approved facility and has passed the most stringent reliability testing. Since it is SMD, it is much easier to integrate and more reliable in high volume production compared to helical antennas which are cumbersome to install and subject to variability due to need for manual assembly.

### Typical Applications:

- Sigfox
- LoRa
- LPWAN
- Automated Meter Reading (AMR)
- RFID
- Remote Monitoring
- Healthcare
- Sensing
- Alarm Systems
- Handheld Devices

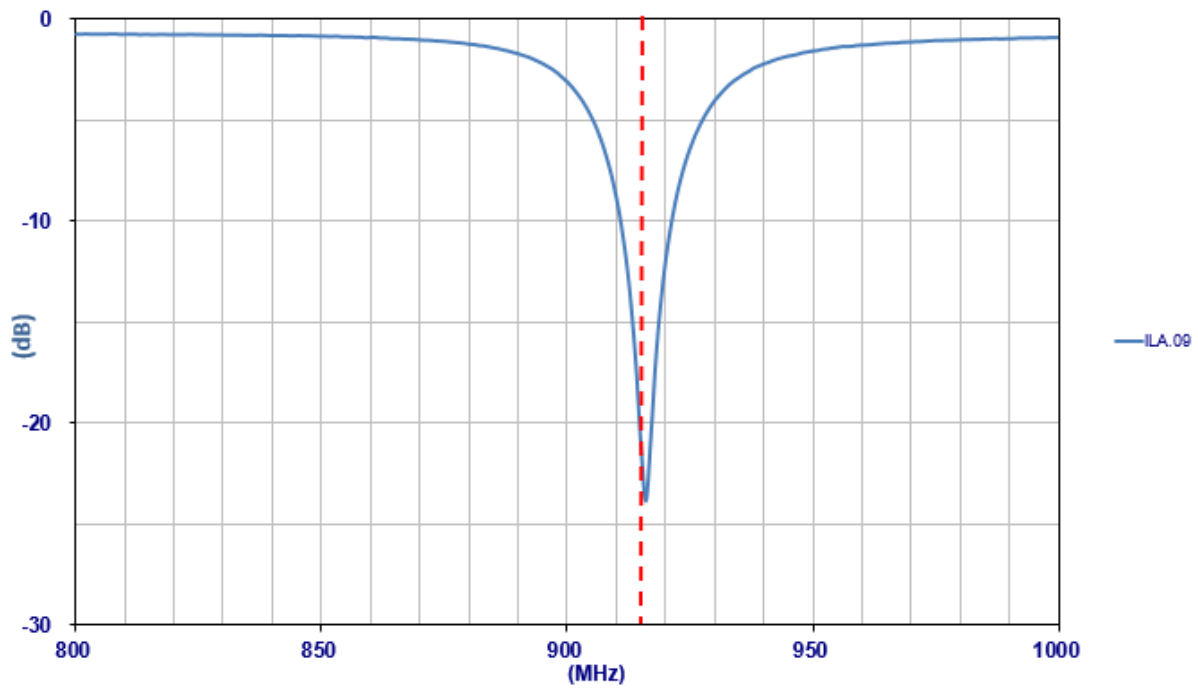
## 2. Specification

ELECTRICAL*			
Center Frequency (MHz)	902	915	928
Peak Gain (dBi)	-3.00	0.39	-1.78
Efficiency (%)	25.66	55.93	34.45
Return Loss (dB)	< -3	< -10	<-3
Impedance (Ω)	50		
Polarization	Linear		
Input Power	2W		
MECHANICAL			
Dimensions (mm)	5.0*3.0*0.5		
Ground plane (mm)	80*40 (Standard Evaluation Board)		
Weight (g)	0.02		
ENVIRONMENTAL			
Operating Temperature	-40°C to 85°C		
Storage Temperature	-40°C to 85°C		
Relative Humidity	20% to 70%		

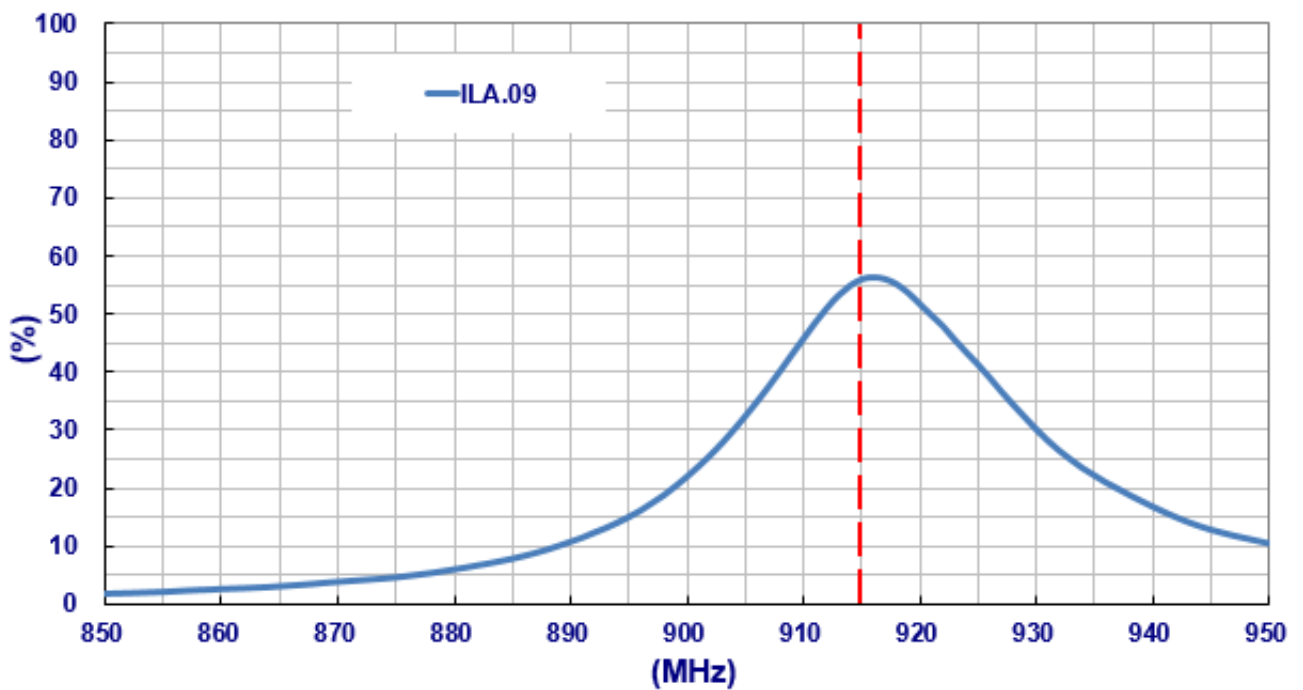
\* Tested on 80\*40mm evaluation board.

## 3. Antenna Characteristics

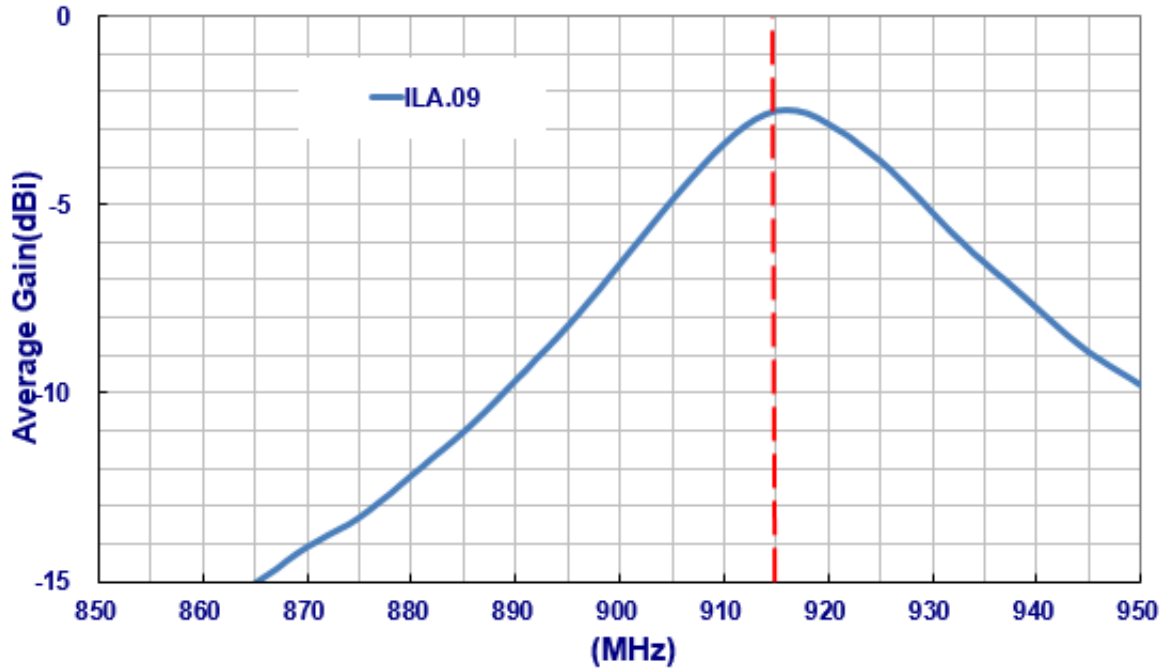
### 3.1 Return Loss



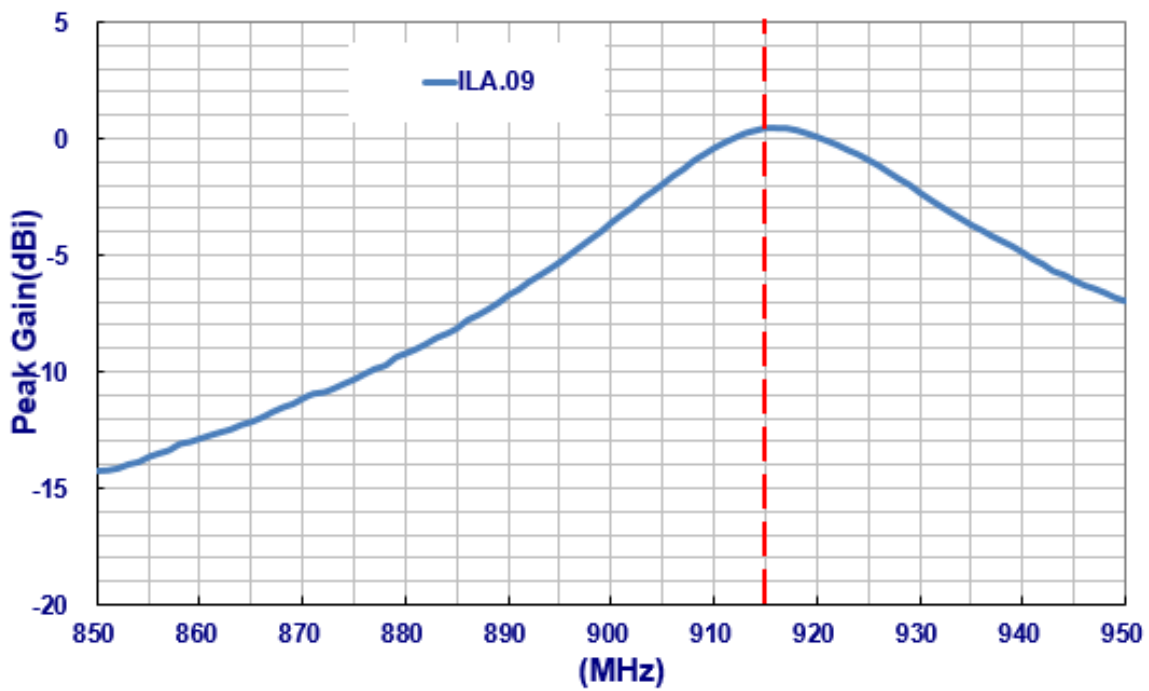
### 3.2 Efficiency



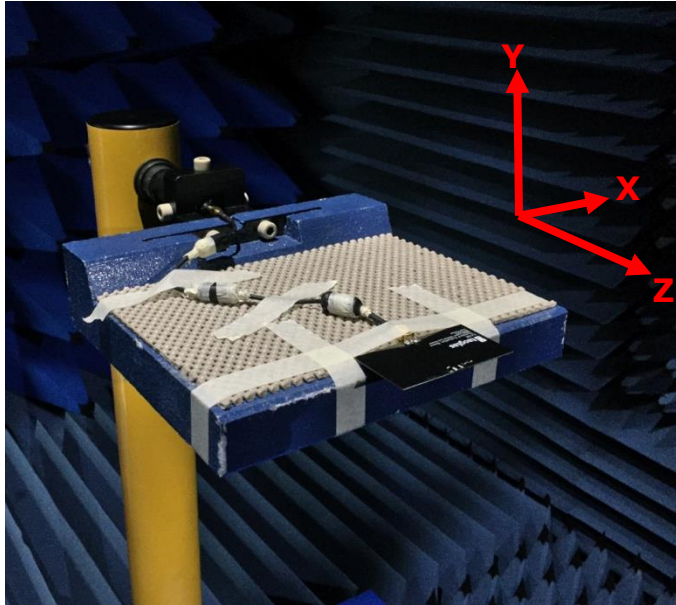
### 3.3 Average Gain



### 3.4 Peak Gain

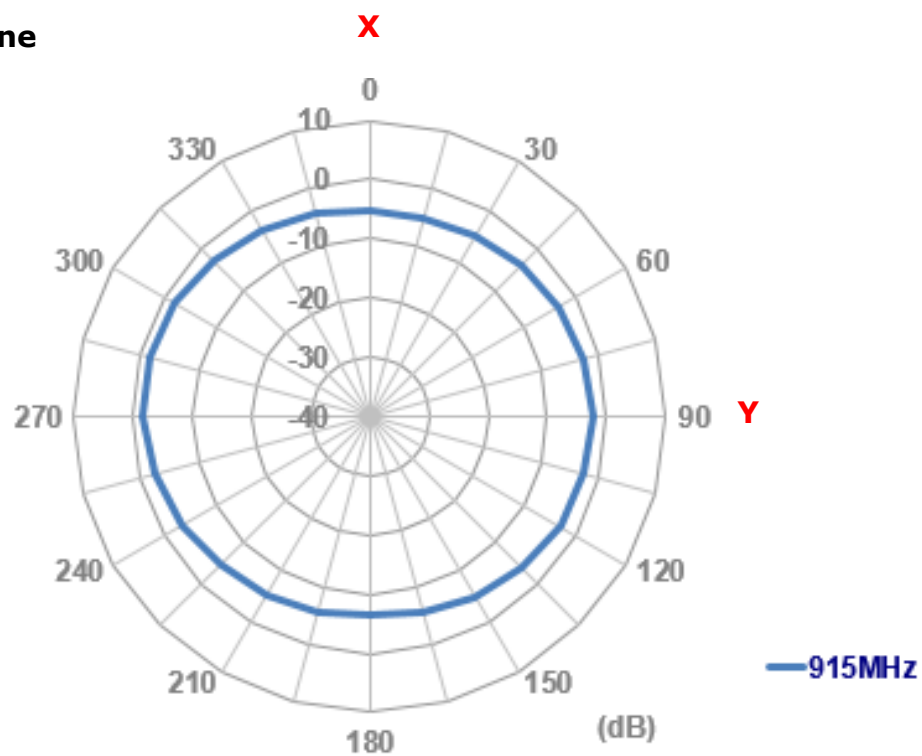


## 4. Antenna Radiation Pattern

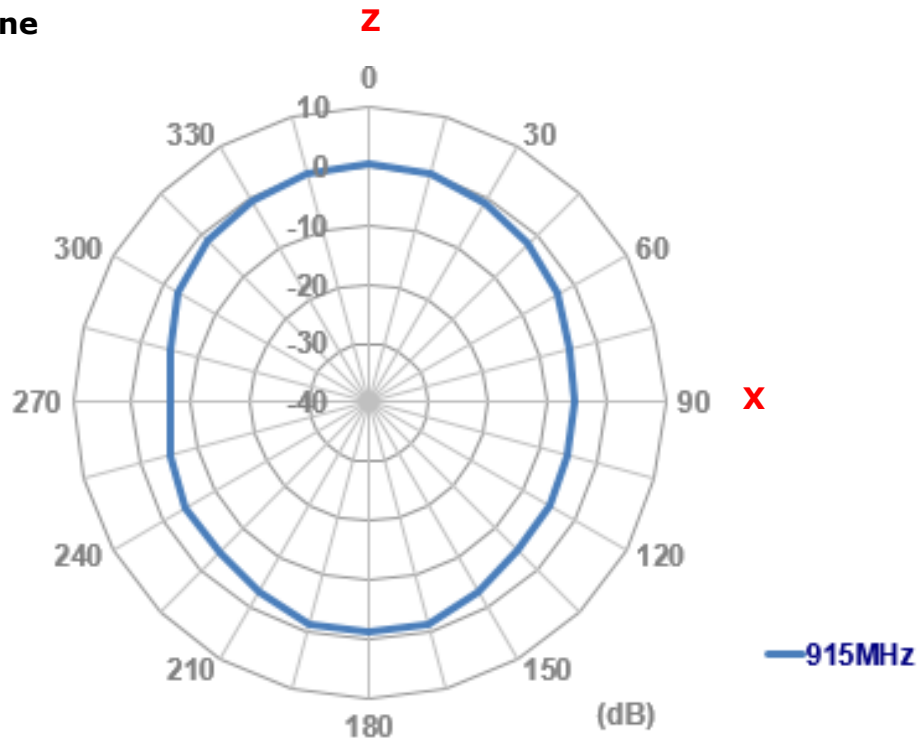


### 4.1 2D Radiation Pattern

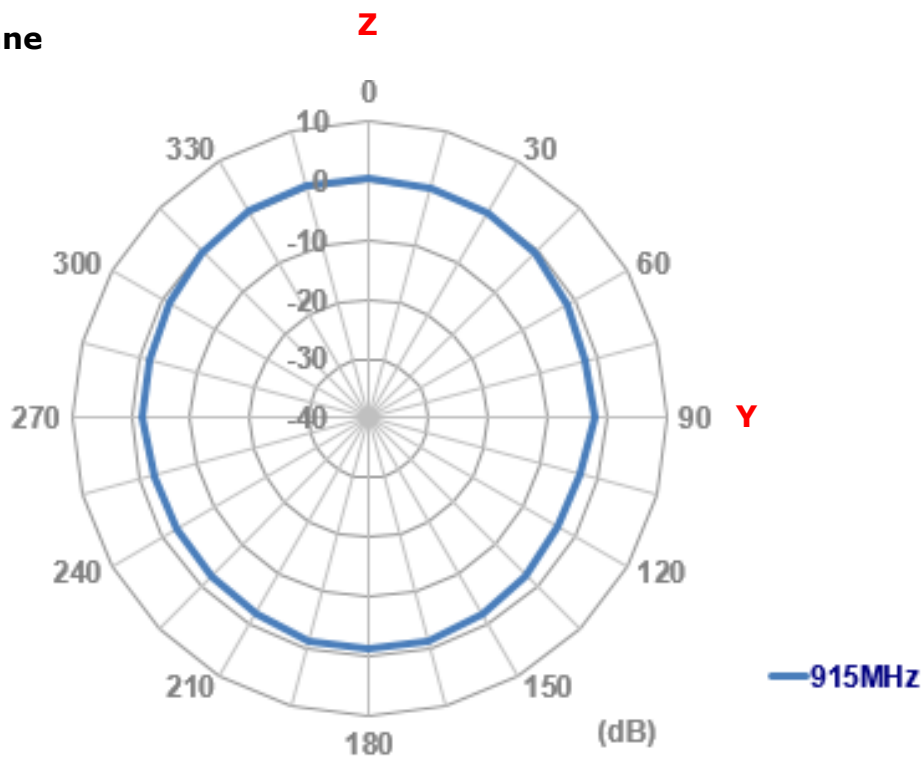
**XY Plane**



### XZ Plane

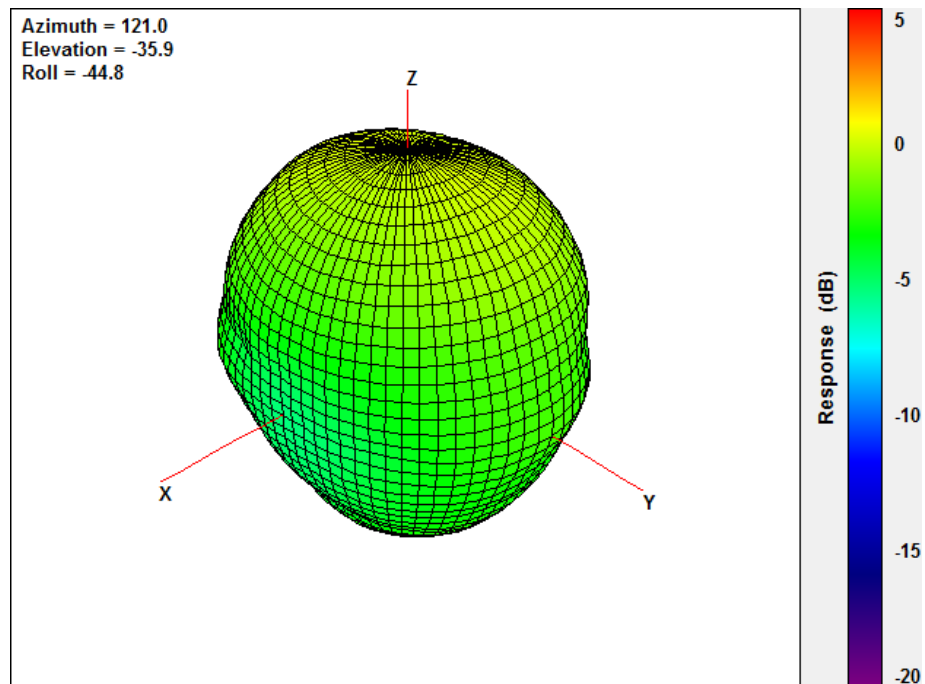


### YZ Plane



## 4.2 3D Radiation Pattern

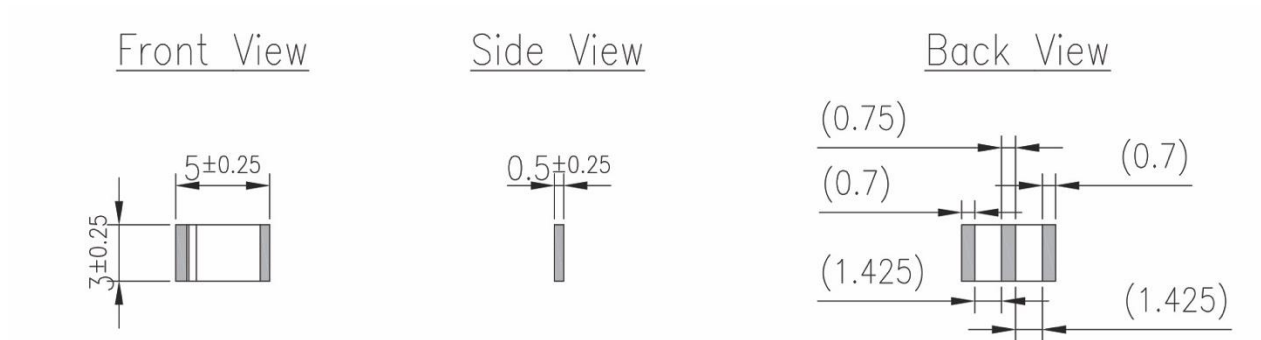
ISM 915MHz



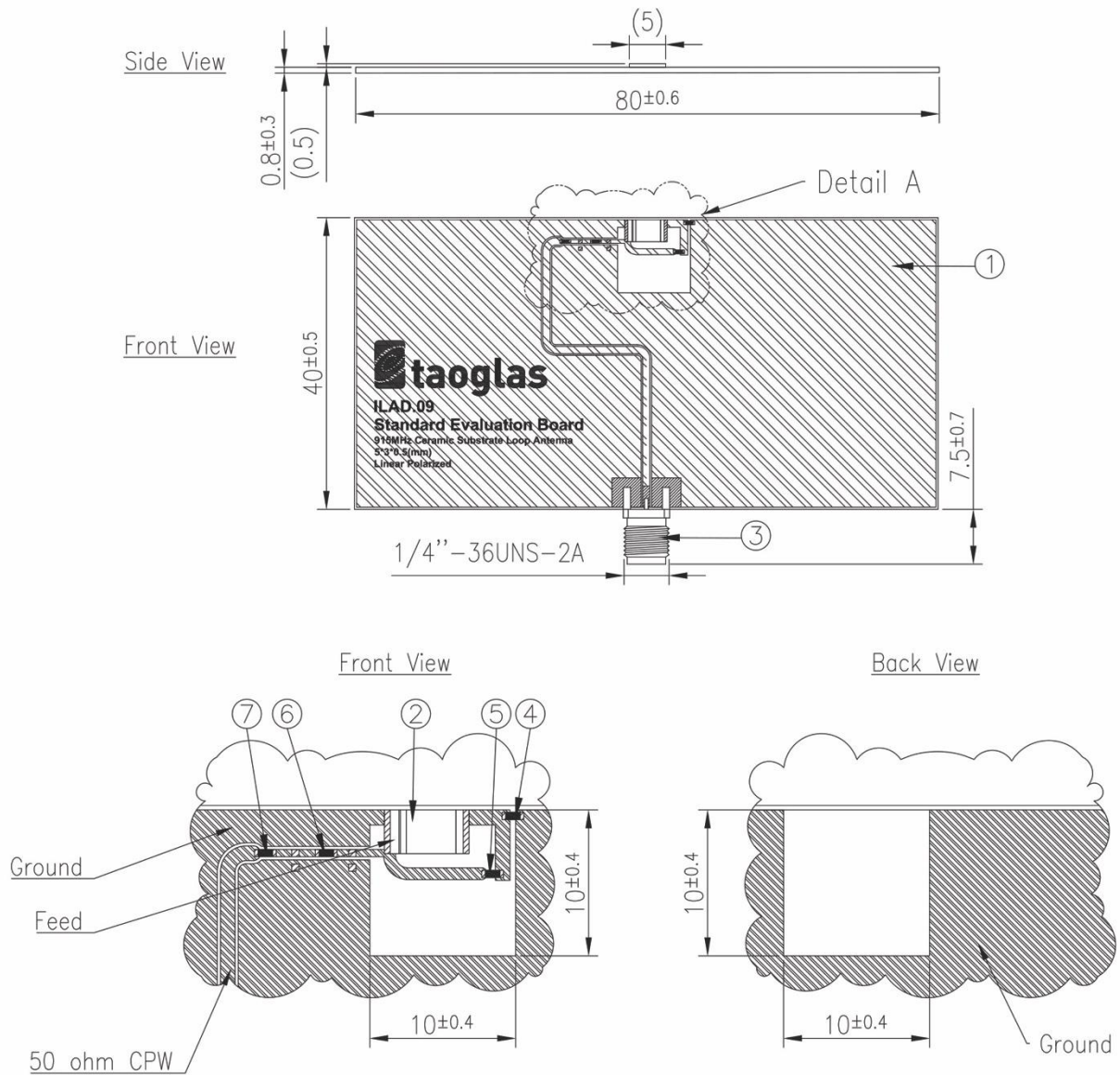


## 5. Mechanical Drawing (Unit: mm)

### 5.1 ILA.09



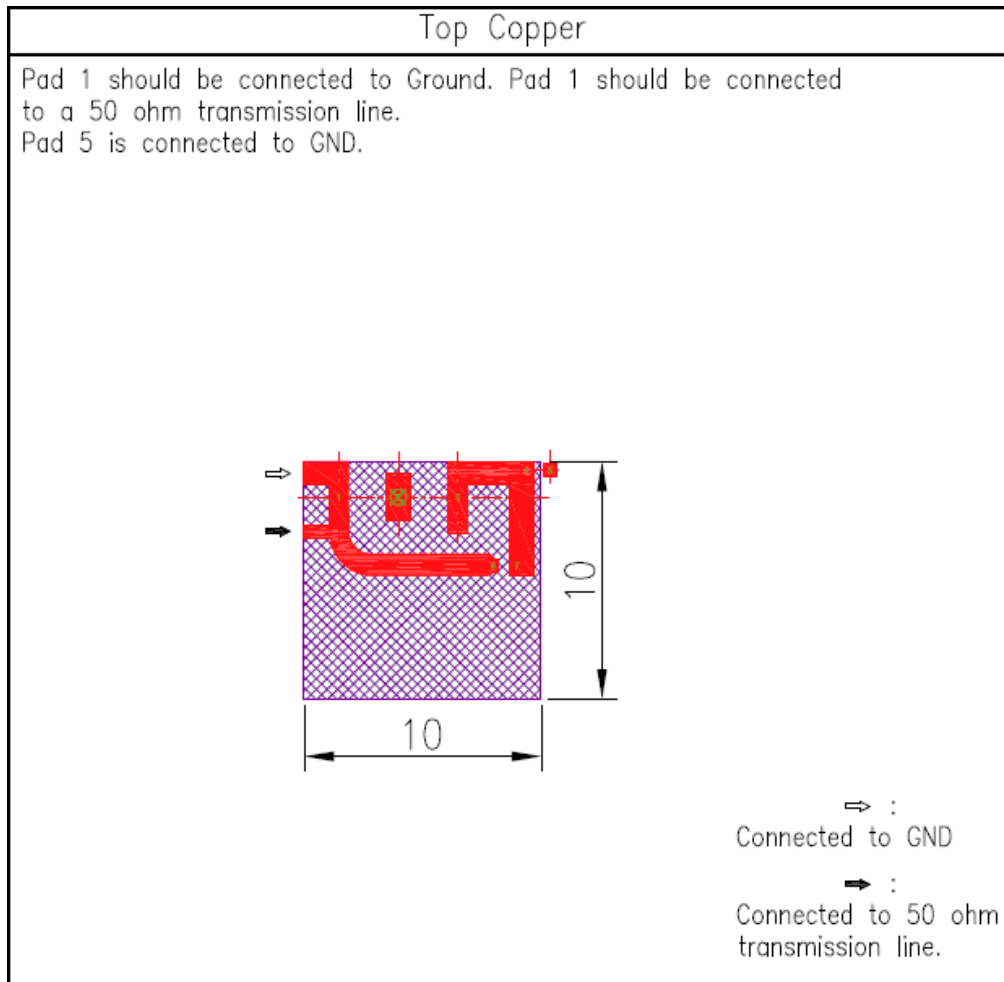
## 5.2 ILAD.09

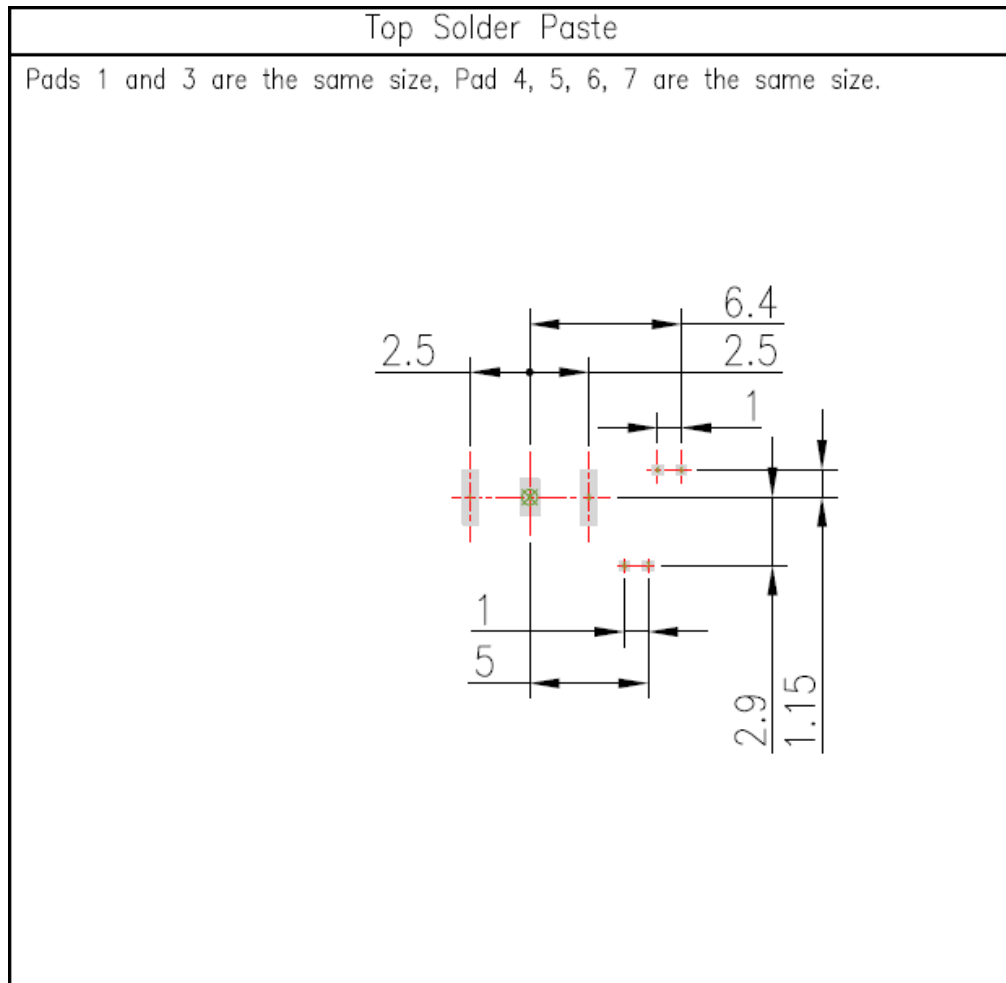


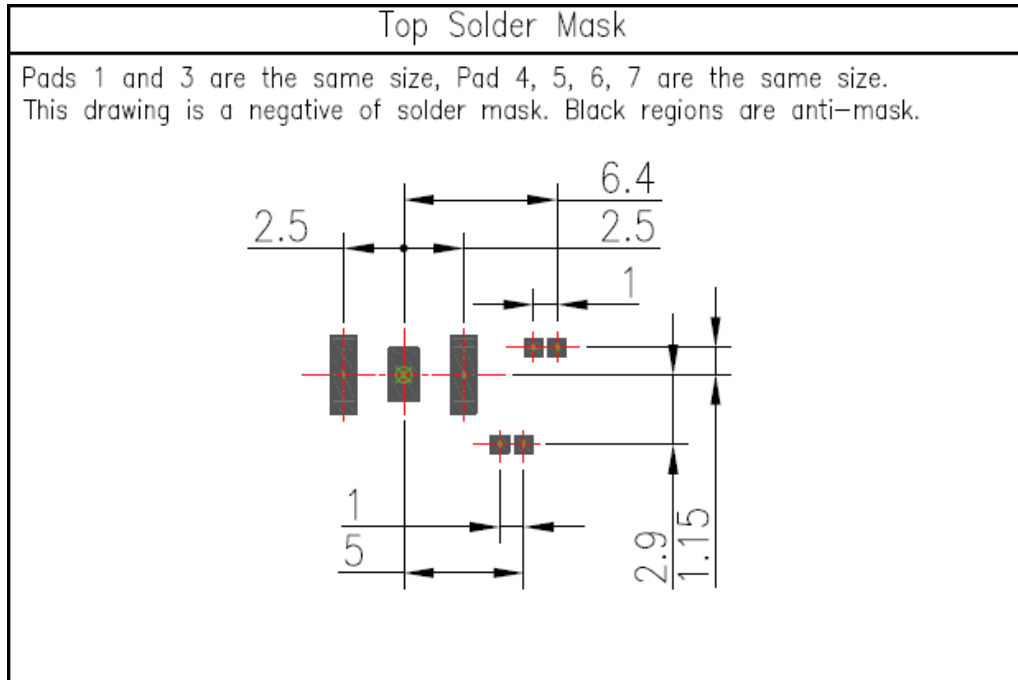
	Name	Material	Finish	QTY
1	ILAD.09 EVB Board	Composite	Black	1
2	ILA.09 Chip Antenna	Ceramic	N/A	1
3	SMA(F) ST	Brass	Au Plated	1
4	Capacitor 3.9pF (0402)	Ceramic	N/A	1
5	Capacitor 2.2pF (0402)	Ceramic	N/A	1
6	Inductor 1.8nH (0402)	Ceramic	N/A	1
7	Capacitor 22pF (0402)	Ceramic	N/A	1

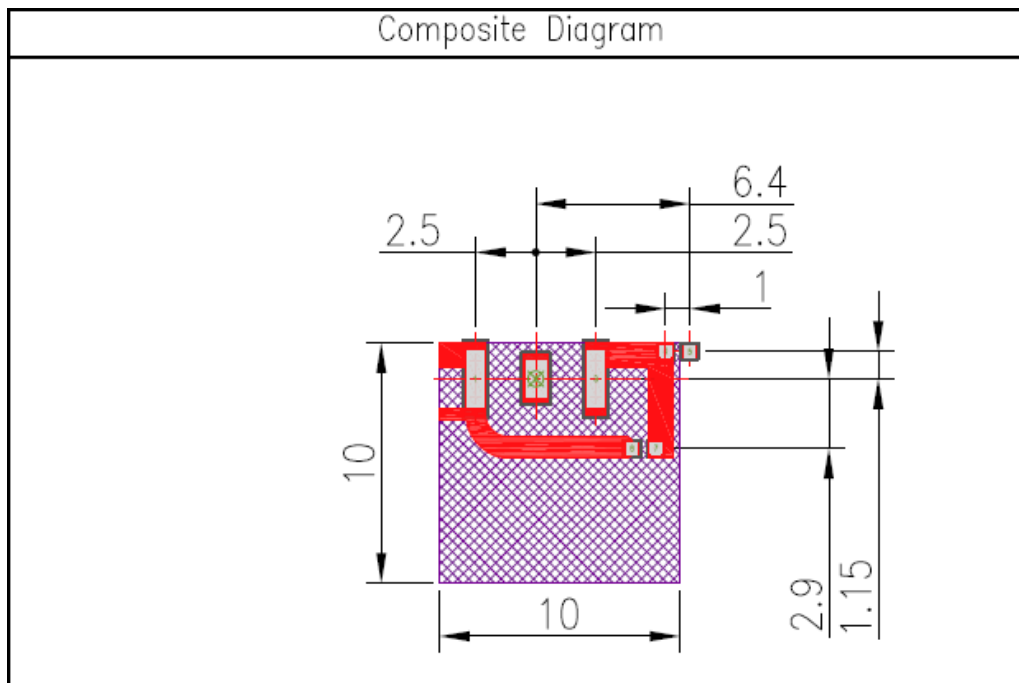
## 6. Layout Guide

### 6.1 Footprint



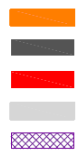






NOTE:

1. Ag Plated area
2. Solder Mask area
3. Copper area
4. Paste area
5. Copper Keepout Area

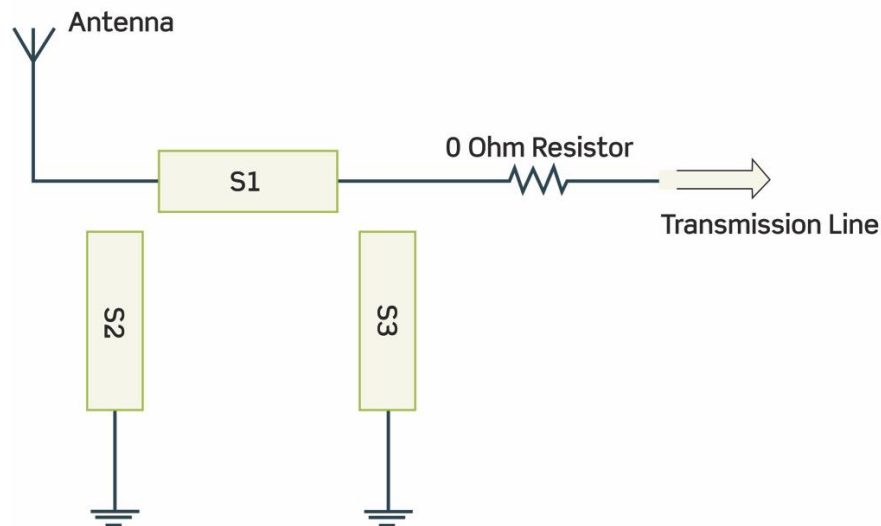


6. Ground keepout should extend from top layer through all inner PCB layers to minimize coupling from RF feed to ground.
7. Any vias in pads should be either filled or tented to prevent solder from wicking away from the pad during reflow.
8. The dimension tolerances should follow standard PCB manufacturing guidelines

\* Footprint drawings in .dwg format will be provided upon request.

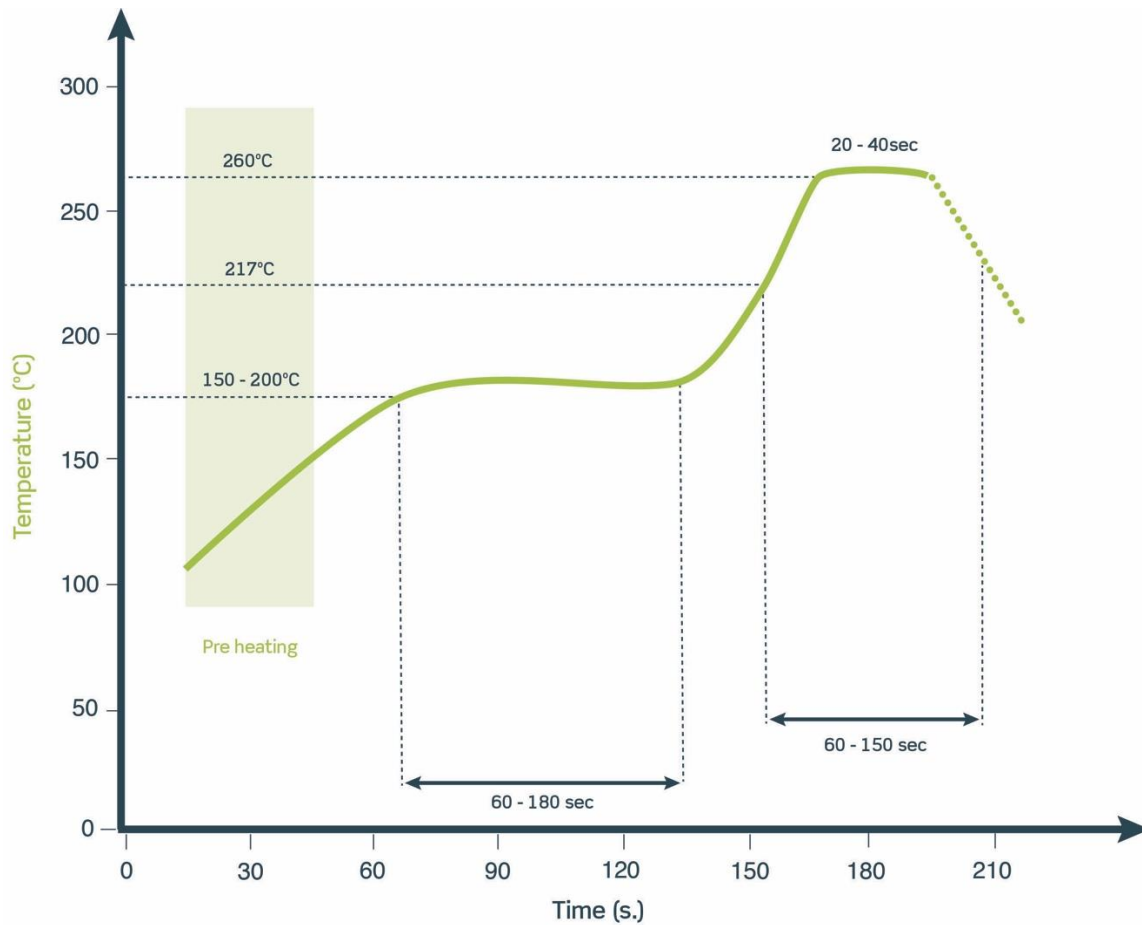
## 6.2 Matching Circuit

Like all antennas, surrounding components, enclosures, and changes to the GND plane dimensions can alter performance. A pi-matching network like the one shown below is required incase adjustments need to be made. The antenna EVB has the same matching network. The components on the EVB are a good starting point for a new design, but will need to be adjusted upon integration for best performance. The zero ohm resistor is needed to solder down a coax pigtail to make measurements with a vector network analyzer.



## 7. Solder Reflow Profile

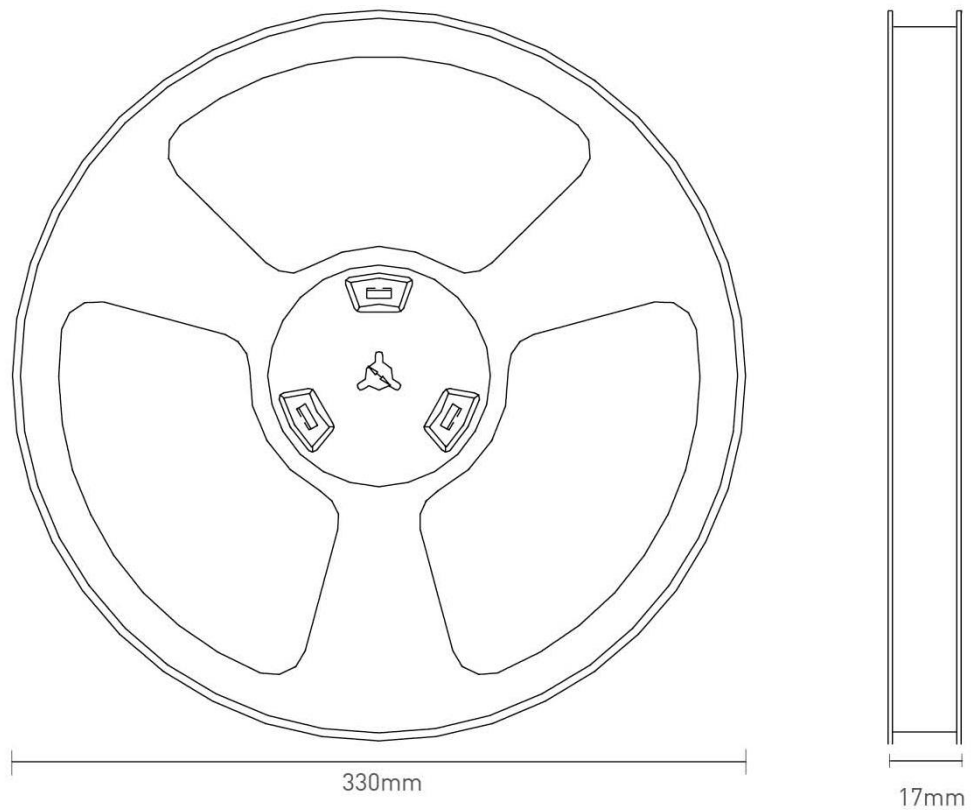
Typical Soldering Profile for Lead-free Process:



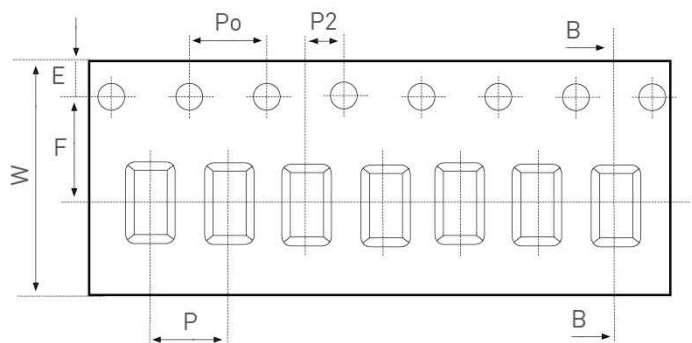


## 8. Packaging

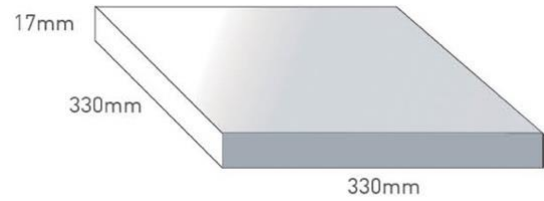
6000 pcs ILA.09 per tape & reel  
 Dimensions - 330\*330\*17mm  
 Weight - 680g



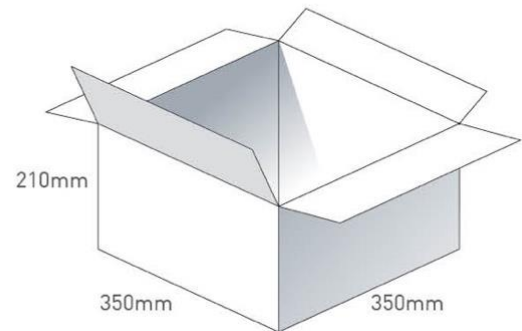
Tape Dimensions (unit: mm)		
Feature	Spec	Tolerances
W	12.00	±0.30
P	4.00	±0.10
E	1.75	±0.10
F	5.50	±0.10
P2	2.00	±0.10
D	1.50	+0.10 -0.00
Po	4.00	±0.10
10Po	40.00	±0.10



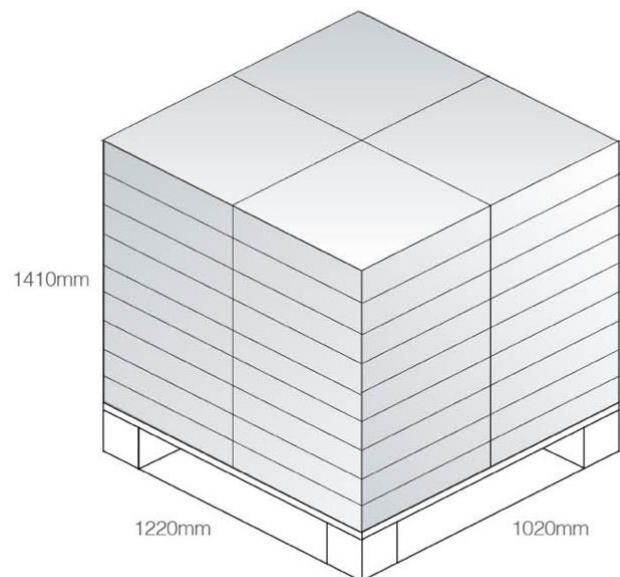
6000 pcs ILA.09  
1 reel in small inner box  
Dimensions - 330\*330\*17  
Weight - 680g



9 boxes / 54000 pcs in one carton  
Carton Dimensions - 350\*350\*210mm  
Weight - 6.69Kg



Pallet Dimensions 1220\*1020\*1410mm  
36 Cartons per Pallet  
4 Cartons per layer  
9 Layers



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